

Runcom incorporates Paragon's CoolPA® chip in its WiMax Reference Designs.

Rishon Letzion Israel and Haifa Israel –February 11, 2008.

Runcom Technologies Ltd, the OFDMA Technology pioneer and Paragon Communications a provider of solutions for enhancing performance of wireless power amplifiers and systems, today announced that Paragon's CoolPA® chip will be incorporated into Runcom's User Terminal and Base Station Reference Designs for Mobile WiMax applications. The CoolPA® chip enhances performance of Power Amplifiers (PA) and attains up to 6dB improvement in output power which implies doubling of transmission range, as well as major efficiency and heat dissipation improvements while maintaining the linearity of the PA in its same level.

“Runcom is a leading player in providing solutions to the emerging WiMax market and we are very pleased with their decision to incorporate our CoolPA® chip in their reference design for the Mobile WiMax market” commented Eli Plotnik Paragon's CEO.

“ The ability to increase output power, significantly widens the effective coverage range of WiMax applications, and as a leader in that market Runcom always aims in bringing the best solutions to our customers. Incorporating Paragon's CoolPA® chip in our design is another step in meeting this goal” added Dr. Zion Hadad Runcom's CEO.

About Runcom Technologies

Runcom is a technology company pioneering OFDMA based silicon solutions for User Terminals and Base Stations that comply with the IEEE802.16e-2005 standard for WiBro and Mobile WiMax applications; Runcom Products include the PHY and MAC communication layers. Runcom RNA200 ASIC was the first Mobile WiMax compliant ASIC in the market. For more information, visit Runcom on the Internet: <http://www.runcom.com> or contact Israel Koffman at israelk@runcom.co.il

About Paragon Communications Ltd.

Paragon Communications Ltd. provides solutions for enhancing performance of wireless power amplifiers and systems. Paragon offers its CoolPA® chips based on its patented XNN® technology that enhances output power, efficiency and simultaneously reduces power consumption and heat dissipation in Wi-Fi, WIMAX, Cellular and other wireless systems. Paragon holds many patents for enhancement of PA's and wireless systems performance.

For more information visit www.paragon-communications.com